



Self-assembled Cu(In,Ga)Se₂ nanocrystals formed by Ar ion beam irradiation

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ABSTRACT

We developed a simple and effective method for the large scale formation of self-assembled Cu(In,Ga)Se₂ (CIGS) nanocrystals by ion beam irradiation. The compositional changes and morphological evolution were observed as a function of the irradiation time. As the ion irradiation time increased, the nano-dots were transformed into a nano-ridge structure due to the competition between sputtering and diffusion processes during irradiation. In terms of the stoichiometry of the CIGS nano-dots, an increase in the Cu content was observed while the Se content decreased. The PL peak of the nano-dots formed CIGS thin film exhibited a blue-shift. Uniformly formed crystalline CIGS nano-dots can be adopted to increase the p–n junction area and the size confinement effect between the CdS and CIGS film in solar cell systems. This simple method can be exploited for band-gap engineering and enhancing photovoltaic properties.

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1. Introduction

Many different materials such as amorphous silicon and polycrystalline chalcopyrite materials of Cu(In,Ga)Se₂ (CIGS) have been employed in thin film photovoltaic systems. In particular, CIGS-based solar cells have advantages of low cost, long-term stability, a high absorption coefficient with a thin layer, and applicability to stiff or flexible substrates [1–3]. Thin film solar cells comprised of CIGS have achieved remarkable conversion efficiencies as high as 20.3% [4]. However, there is still opportunity to increase the cell efficiency. More recently, solar cells based on nanowires or nanocrystals (NCs) have attracted much attention as a promising structure due to their properties including single crystallinity, size confinement, and increased surface to volume ratio. In addition, an array of CIGS NCs often possesses superior optical absorption due to their light-scattering and trapping morphologies. There have been a number of reports on the synthesis of CuInSe₂ NCs using various methods. Qian et al. [5,6] synthesized CuInSe₂ nanoparticles, nanowhiskers, and nanorods via solvothermal reactions of Cu, In, and Ga salts/elements with selenium powders in ethylenediamine. Guo et al. [7] and Koo et al. [8] prepared CuInSe₂ nanorings with a hexagonal shape and NCs with a trigonal pyramidal shape using

oleylamine as a solvent. Peng et al. [9] reported the synthesis of In₂Se₃ and CuInSe₂ nanowires by VLS techniques. Huang et al. [10,11] also reported the CIGS quantum dots on an ITO substrate by magnetron sputtering. In addition, an individual CuInSe₂ nanowire has also been synthesized from a solid-state reaction between an In₂Se₃ nanowire and contacting copper pads [12]. Large scale synthesis of CuSe, CuInSe₂ nanowire was also reported by Xu et al. [13]. However, to the best of our knowledge, there have not been reports on the formation of CIGS NCs directly on the surface of a CIGS thin film to date. In addition, the optical properties can be tuned by tailoring the size and shape of the NCs due to quantum confinement effects on the CIGS surface layer where the electrical junction forms in photovoltaic devices [14]. In this work, we developed a simple and effective method for the formation of self-assembled CIGS NCs by ion beam irradiation on the large scale to increase the p–n junction area from the CIGS/CdS interface. The crystal structure and chemical composition changes of the CIGS NCs were characterized by nano-beam electron diffraction (NBED) measurements and scanning transmission electron microscopy (STEM)/energy dispersive X-ray spectrometry (EDS). The band-gap energies of the CIGS thin films with and without NCs were measured using low temperature photoluminescence (PL).

2. Experimental details

The CIGS thin films were grown by a three-stage process involving the co-evaporation of elemental Cu, In, Ga, and Se on

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molybdenum-deposited soda lime glass. The details of the growth process and the growth conditions have been reported elsewhere [15]. For the Ar ion beam irradiation, the as-grown samples were transferred into a chamber with a broad ion beam system with linear end hall type ion gun and the chamber was evacuated to a base pressure of 2×10^{-5} mbar. The flow rate of Ar gas was 8 sccm and the anode voltage of the ion gun was fixed at 1.0 kV during irradiation. The distance between the ion source and the substrate holder was about 15 cm. A radio frequency (RF) bias voltage of -600 V was applied to the substrate holder and the irradiation time was varied from 1 to 10 min. By considering the current density and irradiation area of the sample, Ar ion beam irradiation for 1 min is equivalent to an ion fluence of 1.91×10^{16} ions/cm². The macro-structural analysis was conducted using X-ray diffraction (XRD) (Panalytical X'pert High-score) with Cu K α X-rays.

The surface morphology of the CIGS thin films was explored using a field-emission scanning electron microscope as part of a dual-beam focused ion beam (FIB) system (Nova 600, FEI). The cross-sectional specimens examined by the transmission electron microscopy (TEM) were prepared by using the FIB. The micro-structure and chemical composition of the samples were analyzed by a high-resolution TEM (JEM-2100F, JEOL) operating at 200 kV combined with scanning transmission electron microscopy (STEM)/energy dispersive X-ray spectrometry (EDS). Nano-beam electron diffraction (NBED) and selected area-diffraction (SAD) experiments were employed to determine the crystallographic phases of the nanocrystals formed on the CIGS films. The optical band-gap was measured by using low-temperature PL (photoluminescence) at an average temperature of 15 K with a diode-pumped (7 mW power) solid state (DPSS) continuous-wave laser operating at 532 nm (SDL-532-300T) and a monochromator (SpectraPro 2300i). Prior to the PL measurements of the ion beam-treated CIGS surfaces, a bare CIGS substrate was tested for its PL emission to determine any fluorescence effects arising from the glass substrate. No fluorescence was detected in the wavelength range that was used for the analysis of the PL peaks of the CIGS thin films.

3. Results and discussion

The grain sizes of the pristine CIGS film grown by the co-evaporation method ranged from 1.5 to 2.3 μm and the film thickness was 2.1 μm , as shown in Fig. 1(a). Fig. 1(b)–(e) display top-view and tilted-view (insets) images revealing the morphologies of the nanostructures formed on the surface as a function of the Ar ion beam irradiation time. A normal incidence and a constant anode voltage of 1 kV were employed for these samples. The average size of the nano-dots was measured to be approximately 23 nm for the 1 min treated sample in Fig. 1(b). No noticeable change in the dot configuration was observed below an irradiation time of 1 min, irrespective of the acceleration voltage. As the acceleration voltage was increased at a given treatment time, the size of nano-dots became larger without any noticeable change in their shape. The smallest nano-dots were about 9 nm after 1 min of treatment. Increasing the irradiation time resulted in a morphological change of the NCs. Nano-dots coexisted with a nano-ridge structure up to an irradiation time of 5 min. As the irradiation time increased, the shape of the nano-dots became elongated and the dots were transformed into nano-ridge structures with a sharp etched top on the ridge with a longer length, as shown in the insets of Fig. 1(d) and (e). XRD spectra were measured to investigate the property change of CIGS thin film before and after ion beam irradiation. Neither the peak

shift nor the new phase was induced by an ion beam irradiation as shown in Fig. 1(f).

In order to understand the formation mechanism of the nanostructures, an in-depth investigation of the crystallographic and elemental changes caused by Ar ion beam irradiation was conducted using analytical TEM/STEM. The cross-sectional TEM image of the ion beam treated specimen is shown in Fig. 2(a). The position [x] marks the nano-dot on the surface of CIGS film coated by an epoxy resin to protect the surface from any possible damage during the FIB sample preparation and the [y] mark represents the inside of the CIGS film. The diameter of a nano-dot is about 23 nm as a single crystalline, as shown in Fig. 2(b) along with a height of less than 13 nm. Clear lattice fringes were observed from the high resolution TEM image of a hemispheric nano-dot, even though the surface layer was irradiated by the ion beam. Normally, ion beam irradiation results in amorphization of the target being bombarded. However, the CIGS surface layer including the nano-dot is crystalline. Therefore, in terms of the crystallinity, the surface properties were not considerably affected by the ion beam irradiation. Indexed-NBED patterns were analyzed for the $[0\bar{2}1]$, $[110]$, and $[221]$ zone axes in Fig. 2(c)–(e), respectively. The angles between the $[110]$ and $[221]$ zone axes and between the $[110]$ and $[0\bar{2}1]$ zone axes were measured to be 36° and 60.8° , respectively. This result confirms the crystallographic system of the nano-dots to be tetragonal, which is the same as the pristine CIGS thin film.

Fig. 2(f) is the STEM/EDS result for the NCs as a function of the Ar ion beam irradiation time. The STEM/EDS analysis confirmed that the chemical composition of the pristine CIGS film labeled [y] in Fig. 2(f) was measured to be Cu (27.45 ± 2.10 at%), In (21.71 ± 2.3 at%), Ga (6.23 ± 1.34 at%), and Se (44.54 ± 2.63 at%). The chemical composition of NCs formed after 1 min and 5 min treatment changed slightly to Cu (34.48 ± 1.52 at% and 34.54 ± 3.04 at%) and Se (38.99 ± 3.05 at% and 38.77 ± 3.84 at%). However, there remained no binary Cu_xSe phase as the quaternary phase, CIGS NCs.

As shown in the line profile of the four elements in the sample treated for 1 min at 1 kV in Fig. 2(g), the most noticeable changes in the composition occurred at the near surface region down to about 35 nm from the surface (including the nano-dot indicated by [x]). This result is attributed to the penetration power of the Ar ion beam at 1 kV. Deviation from the original composition of the pristine CIGS film became greater with the 10 min treated sample. The fractions of Cu and Se were about 38.24 ± 2.64 at% and 36.55 ± 1.74 at%, respectively. However, the contents of In and Ga before and after irradiation remained the same. The amount of the increase of the Cu fraction is similar to the decrease of the Se fraction. In polycrystalline CIGS, a Cu/(In+Ga) ratio greater than 1 generally produces Cu-rich precipitates. It is believed that in Cu-rich films Cu-on-In antisite (Cu_{In}) and In vacancy (V_{In}) defects can be also formed to partially account for the deviation from compositional stoichiometry [16].

The formation mechanism of CIGS NCs can be understood by tracing their morphological evolution and elemental redistribution as a function of the irradiation time. The formation mechanism relies on a natural self-organization mechanism that occurs during the erosion of surfaces, which is based on the interplay between roughening induced by ion sputtering and smoothing due to surface diffusion. The formation kinetics is determined by etching instead of growth. Facsko et al. [17] reported that a formation process for dots is based on a surface instability induced by ion sputtering. It was found that the diameter or wavelength of dots showed no dependency on ion current density in the range of $1\text{--}4 \times 10^{15}$ cm⁻² s⁻¹ and also no dependency on sample temperatures controlled between -60°C and $+60^\circ\text{C}$ by water cooling at an ion energy of 75 to 1800 eV. In these

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